



CS4J60F A9

General Description:

CS4J60F A9, the silicon N-channel Enhanced MOSFETs, is obtained by the super junction technology which reduces the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package type is TO-220F, which accords with the RoHS standard.

Features:

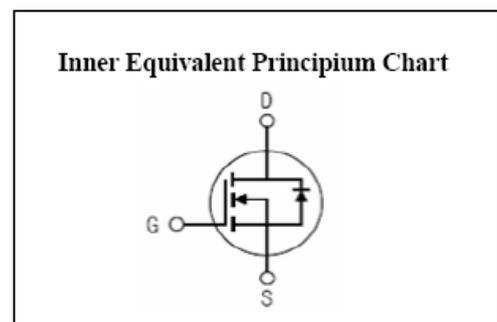
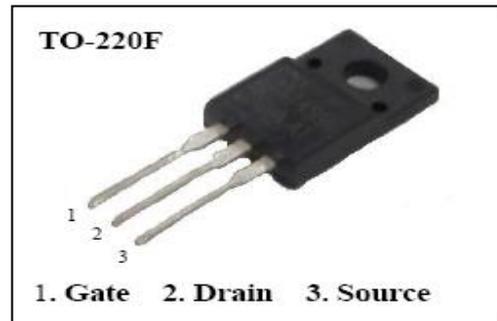
- Fast Switching
- Low Gate Charge
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

Applications:

Power switch circuit of adaptor and charger.

Absolute (Tc= 25°C unless otherwise specified):

|                                       |     |   |
|---------------------------------------|-----|---|
| V <sub>DSS</sub>                      | 600 | V |
| I <sub>D</sub>                        | 4   | A |
| P <sub>D</sub> (T <sub>C</sub> =25°C) | 25  | W |
| R <sub>DS(ON)Typ</sub>                | 1.5 | Ω |



| Symbol                            | Parameter                                    | Rating     | Units |
|-----------------------------------|--|------------|-------|
| V <sub>DSS</sub>                  | Drain-to-Source Voltage(V <sub>GS</sub> =0V) | 600        | V     |
| I <sub>D</sub>                    | Continuous Drain Current                     | 4          | A     |
| I <sub>DM</sub> <sup>a1</sup>     | Pulsed Drain Current                         | 12         | A     |
| V <sub>GSS</sub>                  | Gate-to-Source Voltage                       | ±30        | V     |
| E <sub>AS</sub> <sup>a2</sup>     | Single Pulse Avalanche Energy                | 40         | mJ    |
| dv/dt <sup>a3</sup>               | Peak Diode Recovery dv/dt                    | 5          | V/ns  |
| P <sub>D</sub>                    | Power Dissipation(T=25 °C)                   | 25         | W     |
| T <sub>J</sub> , T <sub>stg</sub> | Operating and Storage Temperature Range      | -55...+150 | °C    |
| T <sub>L</sub>                    | Maximum Temperature for Soldering            | 300        | °C    |

**Electrical Characteristics** (Tc= 25°C unless otherwise specified):

| <b>OFF Characteristics</b>          |                                   |  |        |      |      |       |
|-------------------------------------|-----------------------------------|--|--------|------|------|-------|
| Symbol                              | Parameter                         | Test Conditions  | Rating |      |      | Units |
|                                     |                                   |  | Min.   | Typ. | Max. |       |
| V <sub>DSS</sub>                    | Drain to Source Breakdown Voltage | V <sub>GS</sub> =0V, I <sub>D</sub> =250μA                             | 600    | --   | --   | V     |
| ΔBV <sub>DSS</sub> /ΔT <sub>J</sub> | Bvdss Temperature Coefficient     | I <sub>D</sub> =250uA  | --     | 0.62 | --   | V/°C  |
| I <sub>DSS</sub>                    | Drain to Source Leakage Current   | V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V,<br>T <sub>a</sub> = 25°C | --     | --   | 1    | μA    |
|                                     |                                   | V <sub>DS</sub> =480V, V <sub>GS</sub> = 0V,<br>T <sub>a</sub> = 125°C | --     | --   | 10   |       |
| I <sub>GSS(F)</sub>                 | Gate to Source Forward Leakage    | V <sub>GS</sub> =+30V V <sub>DS</sub> = 0V,                            | --     | --   | 100  | nA    |
| I <sub>GSS(R)</sub>                 | Gate to Source Reverse Leakage    | V <sub>GS</sub> =-30V V <sub>DS</sub> = 0V,                            | --     | --   | -100 | nA    |

| <b>ON Characteristics</b>      |                               |  |        |      |      |       |
|--------------------------------|-------------------------------|--|--------|------|------|-------|
| Symbol                         | Parameter                     | Test Conditions  | Rating |      |      | Units |
|                                |                               |  | Min.   | Typ. | Max. |       |
| R <sub>DS(ON)</sub>            | Drain-to-Source On-Resistance | V <sub>GS</sub> =10V,I <sub>D</sub> =2A                    | --     | 1.5  | 1.8  | Ω     |
| V <sub>GS(TH)</sub>            | Gate Threshold Voltage        | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA | 2.0    | --   | 4.0  | V     |
| Pulse width tp ≤ 300μs, δ ≤ 2% |                               |  |        |      |      |       |

| <b>Dynamic Characteristics</b> |                              |  |        |      |      |       |
|--------------------------------|------------------------------|--|--------|------|------|-------|
| Symbol                         | Parameter                    | Test Conditions  | Rating |      |      | Units |
|                                |                              |  | Min.   | Typ. | Max. |       |
| C <sub>iss</sub>               | Input Capacitance            | V <sub>GS</sub> = 0V V <sub>DS</sub> = 25V<br>f = 1.0MHz | --     | 240  | --   | pF    |
| C <sub>oss</sub>               | Output Capacitance           |  | --     | 180  | --   |       |
| C <sub>rss</sub>               | Reverse Transfer Capacitance |  | --     | 10   | --   |       |

| <b>Resistive Switching Characteristics</b> |                                |  |        |      |      |       |
|--|--------------------------------|--|--------|------|------|-------|
| Symbol                                     | Parameter                      | Test Conditions  | Rating |      |      | Units |
|  |                                |  | Min.   | Typ. | Max. |       |
| t <sub>d(ON)</sub>                         | Turn-on Delay Time             | I <sub>D</sub> =4A V <sub>DD</sub> = 300V<br>V <sub>GS</sub> = 10V R <sub>G</sub> =10Ω | --     | 11   | --   | ns    |
| t <sub>r</sub>                             | Rise Time                      |  | --     | 21   | --   |       |
| t <sub>d(OFF)</sub>                        | Turn-Off Delay Time            |  | --     | 30   | --   |       |
| t <sub>f</sub>                             | Fall Time                      |  | --     | 8    | --   |       |
| Q <sub>g</sub>                             | Total Gate Charge              | I <sub>D</sub> = 4A V <sub>DD</sub> =480V<br>V <sub>GS</sub> = 10V                     | --     | 10   | --   | nC    |
| Q <sub>gs</sub>                            | Gate to Source Charge          |  | --     | 2.0  | --   |       |
| Q <sub>gd</sub>                            | Gate to Drain ("Miller")Charge |  | --     | 5.6  | --   |       |

| Source-Drain Diode Characteristics |  |  |        |      |      |               |
|------------------------------------|--|--|--------|------|------|---------------|
| Symbol                             | Parameter                              | Test Conditions                            | Rating |      |      | Units         |
|                                    |  |  | Min.   | Typ. | Max. |               |
| $I_S$                              | Continuous Source Current (Body Diode) | $T_C=25^\circ\text{C}$                     | --     | --   | 4.5  | A             |
| $I_{SM}$                           | Maximum Pulsed Current (Body Diode)    |  | --     | --   | 13.5 | A             |
| $V_{SD}$                           | Diode Forward Voltage                  | $I_S=4\text{A}, V_{GS}=0\text{V}$          | --     | 0.9  | 1.2  | V             |
| $t_{rr}$                           | Reverse Recovery Time                  | $I_F=I_S, T_J=25^\circ\text{C}$            | --     | 245  | --   | ns            |
| $Q_{rr}$                           | Reverse Recovery Charge                | $dI_F/dt=100\text{A/us}, V_{GS}=0\text{V}$ | --     | 1.4  | --   | $\mu\text{C}$ |

**Thermal Restistance**

| Symbol          | Parameter           | Max. | Units                     |
|-----------------|---------------------|------|---------------------------|
| $R_{\theta JC}$ | Junction-to-Case    | 5    | $^\circ\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Junction-to-Ambient | 62.5 | $^\circ\text{C}/\text{W}$ |

<sup>a1</sup>: Repetitive rating; pulse width limited by maximum junction temperature

<sup>a2</sup>:  $L=20.0\text{mH}, R_g=25\ \Omega, V_{dd}=50\text{V}, \text{Start } T_J=25^\circ\text{C}$

<sup>a3</sup>:  $I_{SD}=4\text{A}, di/dt \leq 200\text{A/us}, V_{DD} \leq BV_{DS}, \text{Start } T_J=25^\circ\text{C}$

Characteristics Curve:

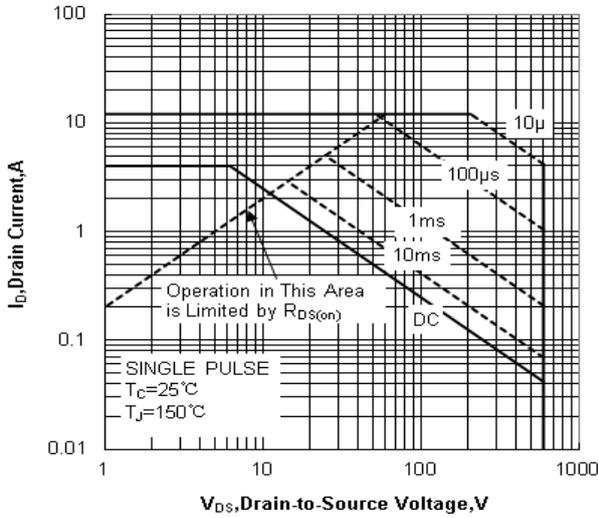


Figure.1 Maximum Forward Bias Safe Operating Area

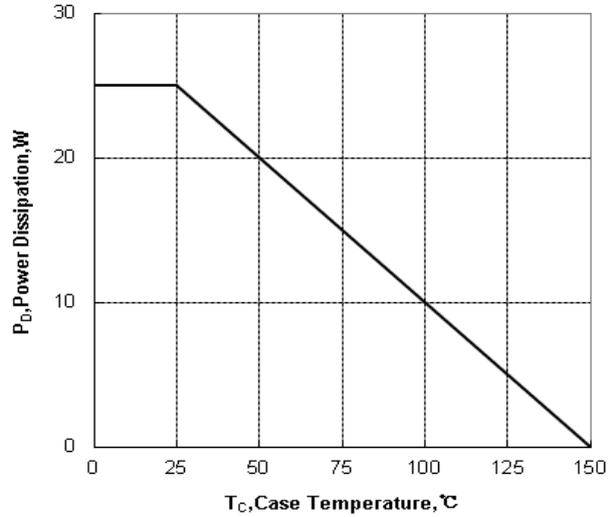


Figure.2 Maximum Power Dissipation vs Case Temperature

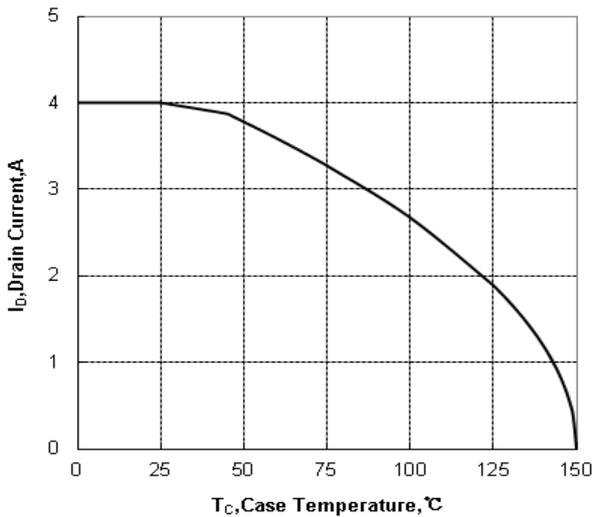


Figure.3 Maximum Continuous Drain Current vs Case Temperature

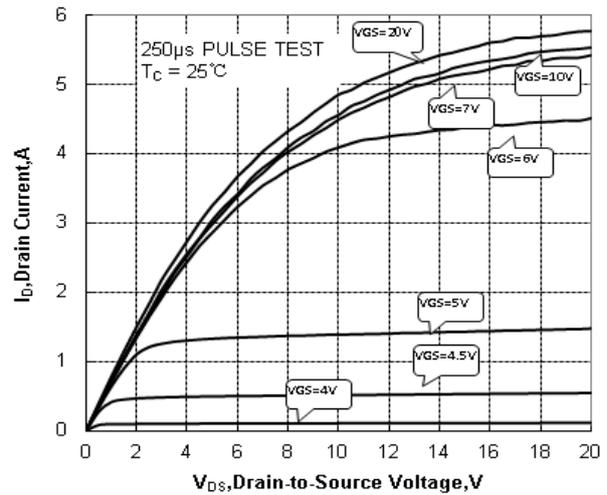


Figure.4 Typical Output Characteristics

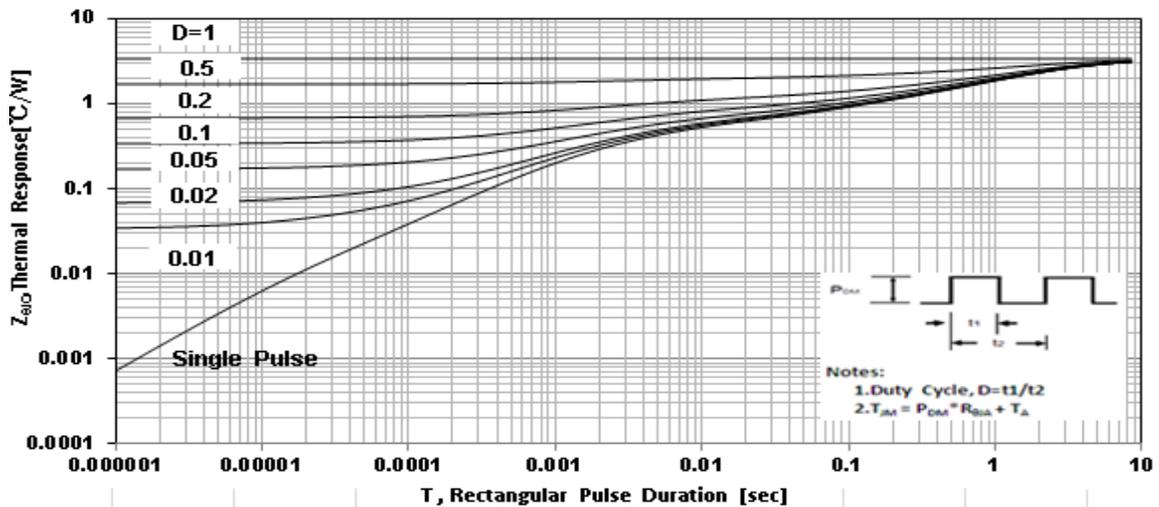


Figure.5 Maximum Effective Thermal Impedance , Junction to Case

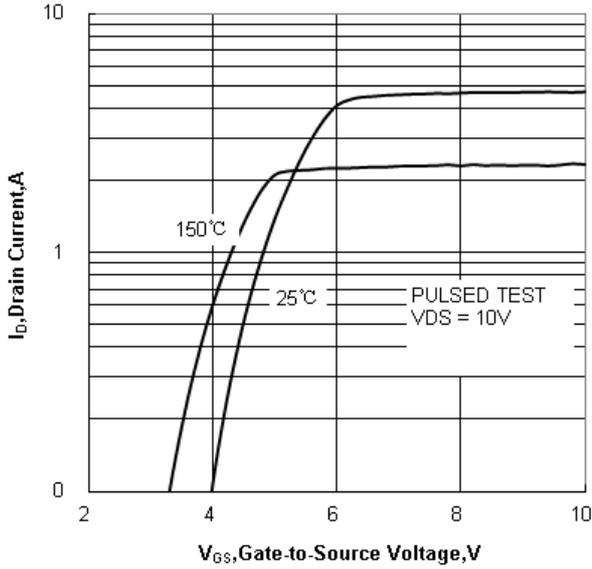


Figure.6 Typical Transfer Characteristics

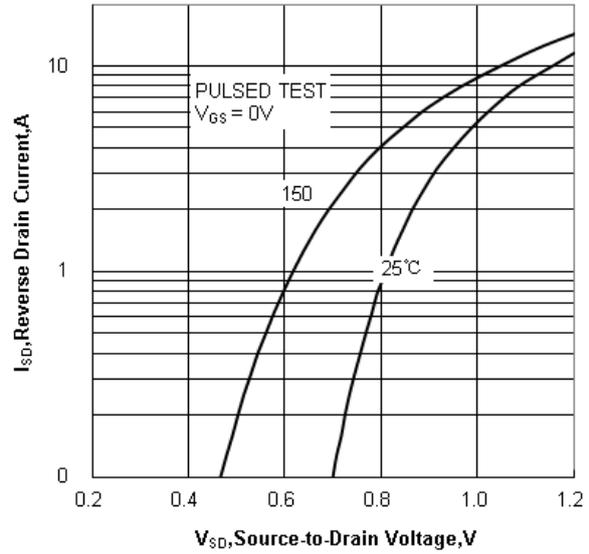


Figure.7 Typical Body Diode Transfer Characteristics

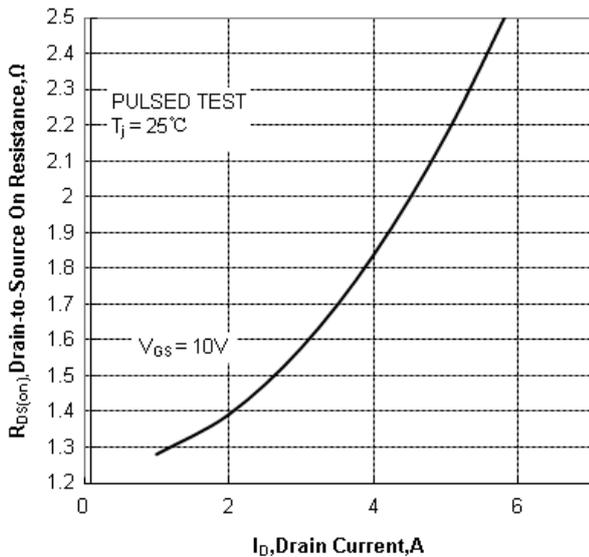


Figure.8 Typical Drain to Source ON Resistance vs Drain Current

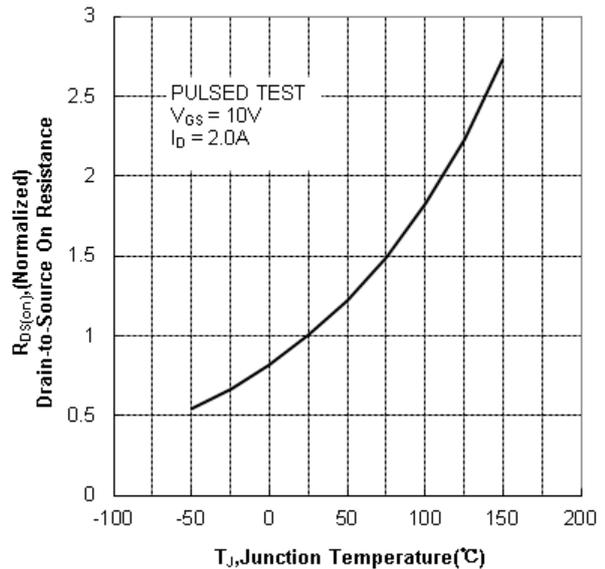


Figure.9 Typical Drian to Source on Resistance vs Junction Temperature

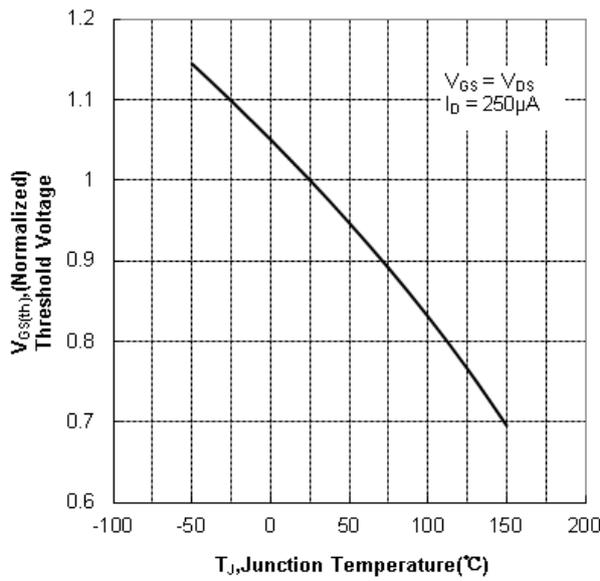


Figure.10 Typical Theshold Voltage vs Junction Temperatur

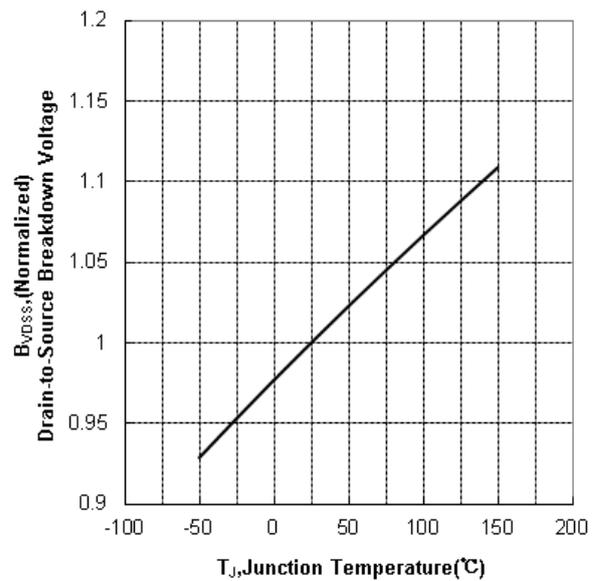


Figure 11 Typical Breakdown Voltage vs Junction Temperature

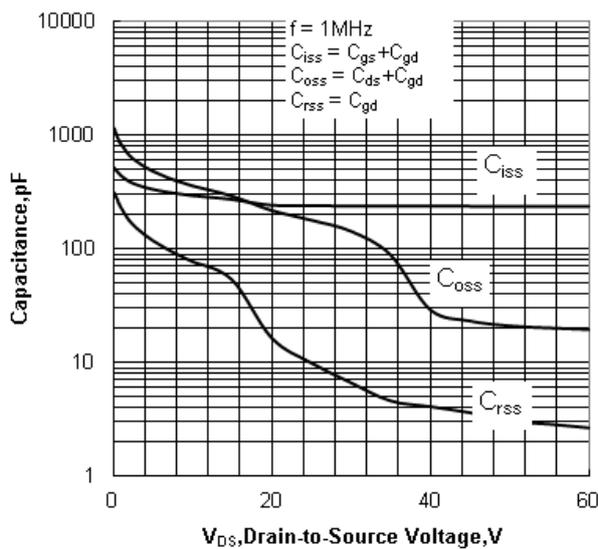


Figure.12 Typical Capacitance vs Drain to Source Voltage

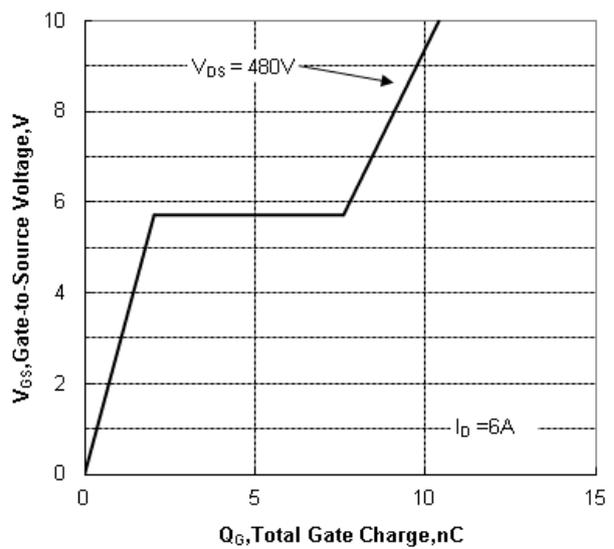


Figure.13 Typical Gate Charge vs Gate to Source Voltage

### Test Circuit and Waveform

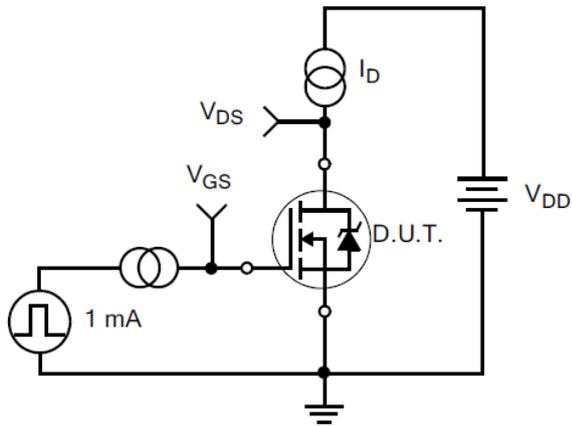


Figure 17. Gate Charge Test Circuit

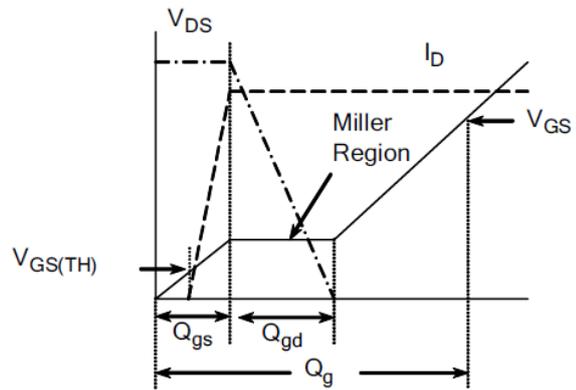


Figure 18. Gate Charge Waveform

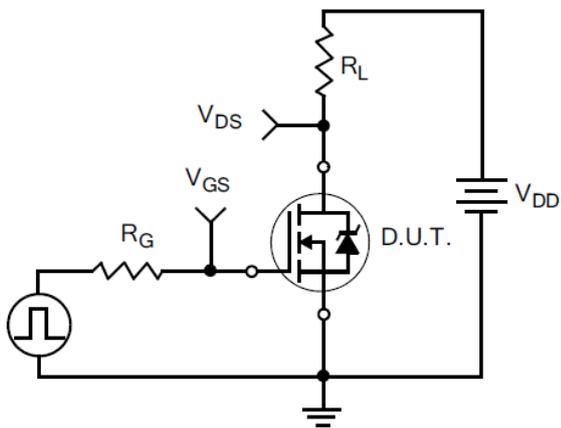


Figure 19. Resistive Switching Test Circuit

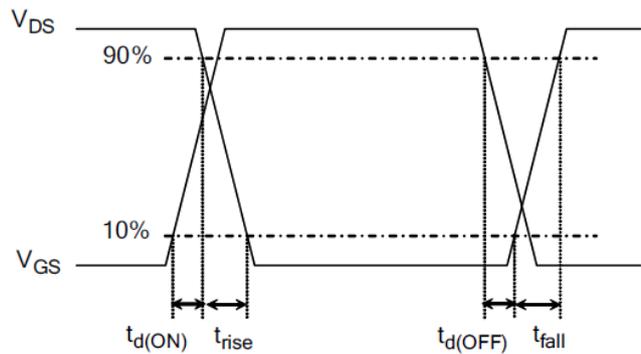


Figure 20. Resistive Switching Waveforms

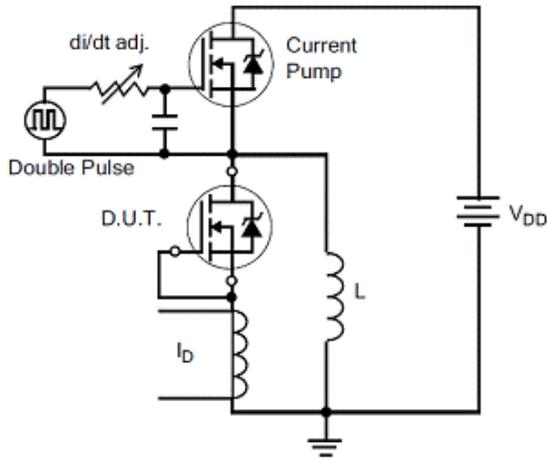


Figure 21. Diode Reverse Recovery Test Circuit

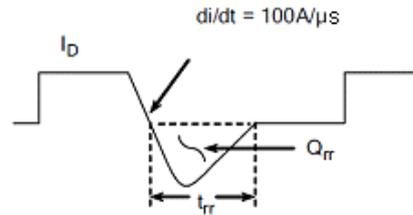


Figure 22. Diode Reverse Recovery Waveform

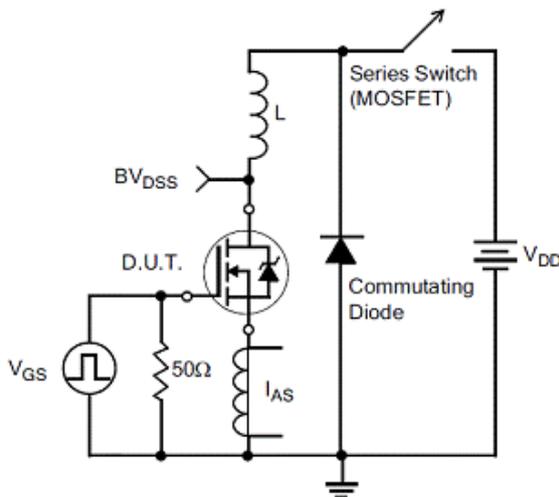


Figure 23. Unclamped Inductive Switching Test Circuit

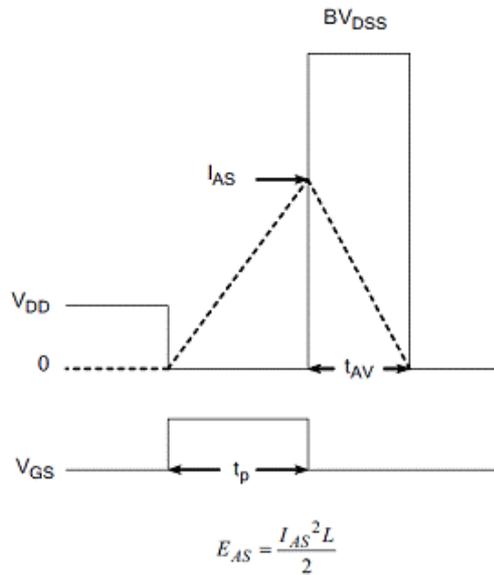
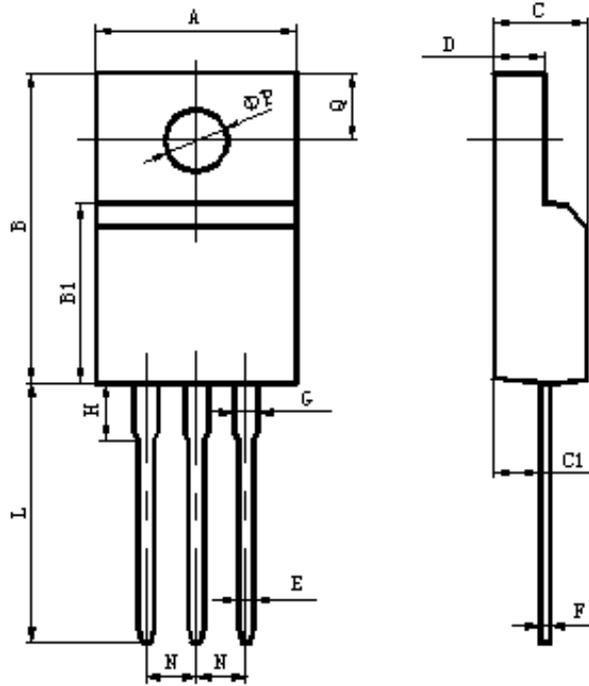


Figure 24. Unclamped Inductive Switching Waveforms

Package Information



| Items | Values(mm) |      |
|-------|------------|------|
|       | MIN        | MAX  |
| A     | 9.60       | 10.4 |
| B     | 15.4       | 16.2 |
| B1    | 8.90       | 9.50 |
| C     | 4.30       | 4.90 |
| C1    | 2.10       | 3.00 |
| D     | 2.40       | 3.00 |
| E     | 0.60       | 1.00 |
| F     | 0.30       | 0.60 |
| G     | 1.12       | 1.42 |
| H     | 3.40       | 3.80 |
|       | 1.60       | 2.90 |
| L*    | 12.0       | 14.0 |
| N     | 2.34       | 2.74 |
| Q     | 3.15       | 3.55 |
| φ P   | 2.90       | 3.30 |

\*:adjustable

TO-220F Package

